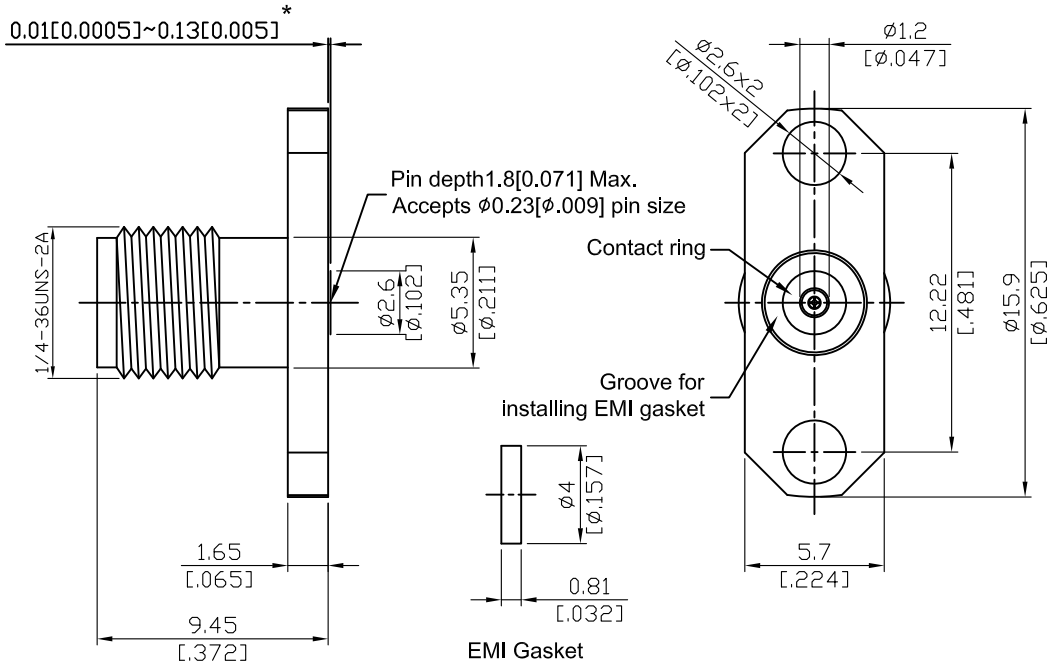


K8F26A-GA09

2.92mm Field Replaceable Jack,
 Φ15.9mm (.625inch) 2 Hole Flange With EMI Gasket,
 Accepts Φ0.23mm (.009inch) Pin, 40GHz VSWR 1.15

50Ω



*360° Raised Metal Contact Ring

Parts	Material	Plating (Micro-inch)
Body	Stainless Steel	Passivated
Insulator	PEI	
Contact Pin	Beryllium Copper	Gold 4 Over Nickel-Phosphorus Alloy 80 Over Copper 20
Contact Ring	Stainless Steel	Passivated
EMI Gasket	Conductive Silicone Elastomers	

This part number complies with RoHS.

Notice: JYEBAO reserves the right to make modifications deemed appropriate.

K	K8F26A-GA09
<div style="border: 1px solid black; padding: 2px; margin-bottom: 5px;">Interface</div> MIL-STD-348B Mechanically compatible with 3.5 & SMA	
<div style="border: 1px solid black; padding: 2px; margin-bottom: 5px;">Electrical Data</div> Impedance 50Ω Frequency range DC to 40GHz VSWR ≤ 1.15 (DC to 40GHz) Insertion loss ≤ 0.04 x √f(GHz) dB Insulation resistance ≥ 5000MΩ Contact resistance inner conductor ≤ 3mΩ Contact resistance outer conductor ≤ 2mΩ Dielectric withstanding voltage (at sea level) 750 V rms Working Voltage (at sea level) 250 V rms RF leakage ≥ 100dB to 1GHz	
<div style="border: 1px solid black; padding: 2px; margin-bottom: 5px;">Mechanical Data</div> Recommended coupling nut torque 11.47 inch lbs Coupling proof torque 15 inch lbs Contact Captivation-axial ≥ 4.9 lbs Durability (mating) ≥ 500	
<div style="border: 1px solid black; padding: 2px; margin-bottom: 5px;">Environmental Data</div> Temperature range -40°C to +150°C Thermal shock MIL-STD-202, Method 107, Condition B Moisture resistance MIL-STD-202, Method 206 Corrosion MIL-STD-202, Method 101, Condition B RoHS Compliant	
<div style="border: 1px solid black; padding: 2px; margin-bottom: 5px;">Accessories</div> Hermetic seal FR009-SEAL1 Launch pin & Dielectric transition FR009-LAUNCH1; FR009-LAUNCH2 Tab pin & Dielectric transition FR009-TAB2; FR009-TAB3 Tab pin FR009-TAB1	

Notice: JYEBAO reserves the right to make modifications deemed appropriate.

Recommended Launch Hole Dimensions :

1. Using Hermetic seals



Hermetic seal P/N

FR009-SEAL1

2. Using dielectric with Tab or Launch pin



"A" = Substrate thickness

"B" = A + 1/2 Tab or Launch terminal

Dielectric and Tab/ Launch pin P/N	Recommended Launch hole dia.	Recommended Launch hole length
FR009-LAUNCH1	$\phi 0.74 (.029)$	4.75 (.187)
FR009-LAUNCH2	$\phi 0.74 (.029)$	3.18 (.125)
FR009-TAB2	$\phi 0.74 (.029)$	3.18 (.125)
FR009-TAB3	$\phi 0.74 (.029)$	4.75 (.187)

3. Using Tab pin



Tab pin P/N

FR009-TAB1

K8F26A-GA09 (Tested back to back)

